# MA3X748 (MA748)

### Silicon epitaxial planar type

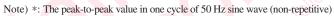
For high frequency rectification

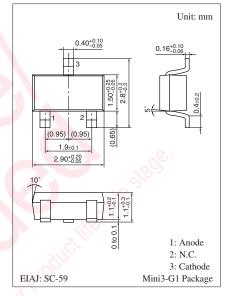
#### Features

- Low V<sub>F</sub> type of MA3X720 (MA720)
- Low forward voltage V<sub>F</sub> and good rectification efficiency
- Optimum for high frequency rectification because of its short reverse recovery time t<sub>rr</sub>

Absolute Maximum Ratings $T_a = 25^{\circ}C$						
Parameter	Symbol	Rating	Unit			
Reverse voltage	V <sub>R</sub>	20	V			
Repetitive peak reverse voltage	V <sub>RRM</sub>	20	V			
Forward current (Average)	I <sub>F(AV)</sub>	500	mA			
Non-repetitive peak forward surge current *	I <sub>FSM</sub>	3	A			
Junction temperature	Tj	125	°C			
Storage temperature	T <sub>stg</sub>	-55 to +125	°C			

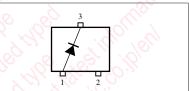
Absolute Maximum Ratings  $T_a = 25^{\circ}$ 





#### Marking Symbol: M4E

#### Internal Connection

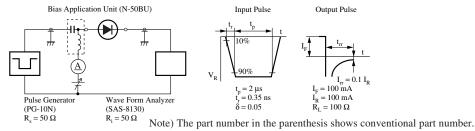


#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

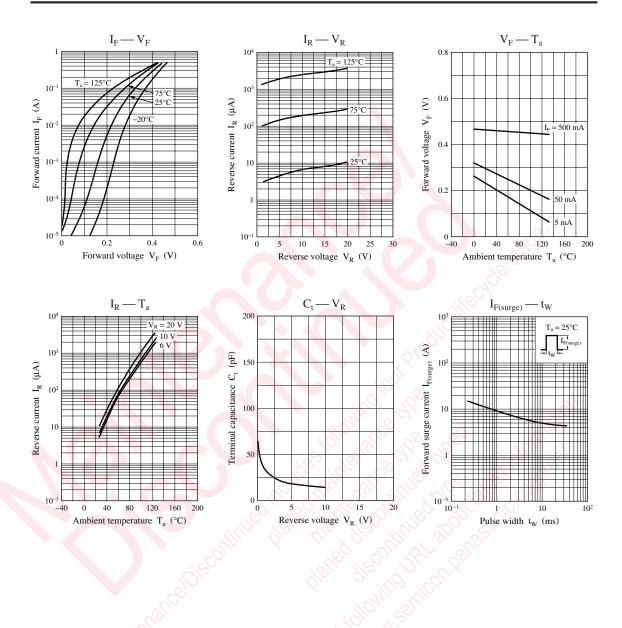
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F1</sub>	$I_F = 10 \text{ mA}$	3		0.3	V
	V <sub>F2</sub>	$I_{\rm F} = 500 \text{ mA}$	N.X		0.5	
Reverse current	I <sub>R</sub>	$V_R = 10 V$			30	μΑ
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$		60		pF
Reverse recovery time	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$		5		ns
		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. Absolute frequency of input and output is 400 MHz.
- 4. \*: t<sub>rr</sub> measurement circuit



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